

ECTC 2005

The 55th Electronic Components
and Technology Conference

May 31 - June 3, 2005
Wyndham Palace Resort & Spa
Lake Buena Vista, Florida

*The only event
that encompasses
the diverse world
of integrated
systems packaging*

HIGHLIGHTS

- 38 technical sessions, including 2 poster sessions
- 16 CEU-approved professional development courses
- Technology Corner Exhibits, featuring more than 70 industry-leading vendors
- Emerging Technology Sessions, featuring Nano-Scale and Biomedical Packaging
- Panel Discussion – Lead-Free Industry Update
- Plenary Session – Global Manufacturing

More than 300 technical papers covering:

- Advanced Packaging
- Modeling & Simulation
- Optoelectronics
- Interconnections
- Materials & Processing
- Quality & Reliability
- Manufacturing Technology
- Components & RF
- Packaging Education

*Don't miss out on the industry's premier event.
For more information, visit:*

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Conference Sponsors:

